

November 2010

- Pletronics' OeD4 is from the OeXO<sup>™</sup> Series of temperature compensated voltage controlled crystal oscillator with a CMOS output.
- 3.2 x 5 mm LCC Ceramic Package
- Supply Voltage: 3.3V
- Cut Tape -or- Tape and Reel packaging

# Pletronics Inc. certifies this device is in accordance with the RoHS 6/6 (2002/95/EC) and WEEE (2002/96/EC) directives.

Pletronics Inc. guarantees the device does not contain the following: Cadmium, Hexavalent Chromium, Lead, Mercury, PBB's, PBDE's Weight of the Device: 0.10 grams Moisture Sensitivity Level: 1 As defined in J-STD-020D.1 Second Level Interconnect code: e4



### Absolute Maximum Ratings:

Parameter	Unit
V <sub>cc</sub> Supply Voltage	-0.5V to +6.5V
Vi Input Voltage	-0.5V to V <sub>cc</sub> + 0.5V
Vo Output Voltage	-0.5V to $V_{cc}$ + 0.5V

### **Thermal Characteristics**

The maximum die or junction temperature is 155°C

The thermal resistance junction to board is 30 to 50°C/Watt depending on the solder pads, ground plane and construction of the PCB.

#### ESD Rating

Model	Minimum Voltage	Conditions	
Human Body Model	1500	MIL-STD-883 Method 3115	
Charged Device Model	1000	JESD 22-C101	



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#### **Part Marking:**

_		1920	=	26.00MHz, the crystal frequency
		yww	=	Year and Week of the crystal manufacture
	2600. <i>yww</i>	PLE	=	Pletronics
	PLExYWWz	Х	=	Model number, normally a "B"
		YWW	=	Year and Week of assembly of the TCXO
		Z	=	internal factory code

The actual part number is OED4215-26.00M where the model number "215" is the specification number the part is made to. This is not included in the part marking. This is included on the label on the Tape and Reel.

#### Package Labeling

Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Courier New Bar code is 39-Full ASCII The bar code will show the actual Part Number (OED4215-26.00M)



Label is 1" x 2.6" (25.4mm x 66.7mm) Font is Arial

**RoHS** Compliant

2nd LvL Interconnect Category=e4 Max Safe Temp=260C for 10s 2X Max

#### **Reliability:** Environmental Compliance

Parameter	Condition		
Mechanical Shock	MIL-STD-883 Method 2002, Condition B		
Vibration	MIL-STD-883 Method 2007, Condition A		
Solderability	MIL-STD-883 Method 2003		
Thermal Shock	MIL-STD-883 Method 1011, Condition A		



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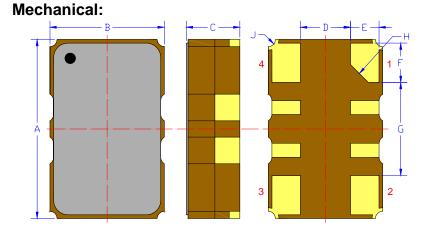
# Electrical Specification for specified Vcc= 3.3V $\pm$ 5% over the specified temperature range.

Item	Min	ТҮР	Max	Unit	Condition		
Frequency Stability over temperature	-250	-	250	ррb	Over -40°C to 85°C	at fixed supply voltage + load (reference to midpoint min/max frequency)	
Holdover	-250 -125	0 0	250 125	ppb ppb	Over -40°C to 85°C fo Over <u>+</u> 5°C change fo		
Frequency Calibration	-2.0	-	2.0	ppm	Frequency offset at 2 60 minutes after refle		
Supply voltage stability	-10	0	10	ppb	± 2% variation in sup	ply voltage	
Load sensitivity	-5	-	5	ppb	10K ohm <u>+</u> 5%    10 p	oF <u>+</u> 10%	
Warm Up	-	0.4	3.0	S	Time to reach specifi	ed frequency	
Aging rate following reflow	-	±10 ±3 ±1	-	ppb/day	1 day after reflow 7 days after reflow 30 days after reflow		
Long term stability (Aging)	-1000 -1500 -4600	-	1000 1500 4600	ppb	after 1 year after 5 years after 15 years		
Output Waveform		CI	MOS				
Output V <sub>HIGH</sub>	90	-	-	%Vs	Load: 10K ohm <u>+</u> 5%    10 pF <u>+</u> 10%		
Output V <sub>LOW</sub>	-	-	10	%Vs	Vth: T <sub>R</sub> and T <sub>F</sub> 10% a	and 90% of amplitude	
$T_{RISE}$ and $T_{FALL}$	-	-	6.5	nS	Vth: D.C. 50% of amp		
Duty Cycle	40	50	60	%			
Phase Noise 1 Hz 10 Hz 100 Hz 1 KHz 10 KHz 100 KHz		-71 -93 -117 -138 -152 -155		dBc/Hz	at 25℃		
Jitter	-	-	0.6	pS	Frequency offset from	n carrier 12kHz to 20MHz	
V Supply Range <sup>1</sup> V <sub>cc</sub>	3.13	3.30	3.47	Volts			
Supply Current I <sub>cc</sub>	-	-	3.0	mA			
Vcontrol Range	0.5	-	2.50	Volts	1.50 volts nominal		
Frequency Pullability	5	-	10	±ppm	Slope positive		
Linearity	-	0.05	2.0	%	In accordance with M	IL-PRF-55310	
Operating Temperature	-40	-	+85	С°	Widest range allowed	1	
Storage Temperature	-55	-	+95	°C			

Note: <sup>1</sup> For correct operation a 10nF supply de-coupling capacitor should be placed next to the device.



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	Inches	mm	
А	0.197 <u>+</u> 0.008	5.00 <u>+</u> 0.20	
В	0.126 <u>+</u> 0.008	3.20 <u>+</u> 0.20	
С	0.059 max	1.50 max	
D <sup>1</sup>	0.0.55	1.40	
E <sup>1</sup>	0.031	0.80	
$F^1$	0.043	1.10	
G <sup>1</sup>	0.102	2.60	
H <sup>1</sup>	0.013C	0.50C	
$J^1$	0.008	0.20R	

Not to Scale

<sup>1</sup> Typical dimensions

Contacts:

Gold 11.8 to 39.4 µinches (0.3 to 1.0 µm)

over

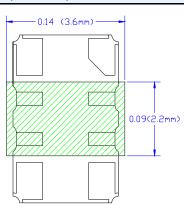
Nickel 50 to 350  $\mu inches$  (1.27 to 8.89  $\mu m)$ 

Pad	Function	Note
1	Vcontrol Input	If this function is not specified, recommend connecting this pad to ground.
2	Ground (GND)	
3	Output	CMOS
4	Supply Voltage (V <sub>cc</sub> )	Connect an appropriate power supply bypass capacitors as close as possible.
-	N. C.	All other pads on the bottom shall not be connected. These are internally connected and were for the TCXO compensation process

### Layout and application information

All connection points in the designated region have solder mask cover to avoid any electrical connections

For Optimum Stability and Jitter Performance, Pletronics recommends:

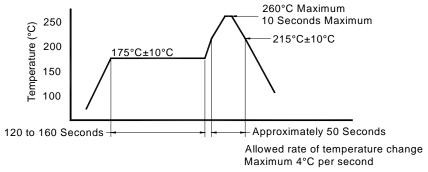


- a ground plane under the device
- no large transient signals (both current and voltage) should be routed under the device
- do not layout near a large magnetic field such as a high frequency switching power supply
- do not place near piezoelectric buzzers or mechanical fans.
- minimize air flow across the device



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### Reflow Cycle (typical for lead free processing)



The part may be reflowed 2 times without degradation.

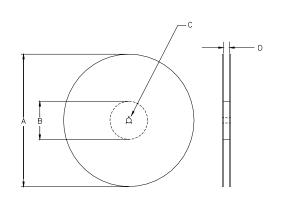
### Tape and Reel: available for quantities of 250 to 1000 per reel, cut tape for < 250

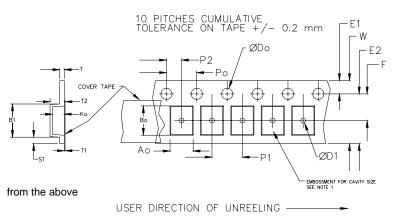
Not to scale

Constant Dimensions Table 1								
Tape Size	D0	D1 Min	E1	P0	P2	S1 Min	T Max	T1 Max
8mm		1.0			2.0			
12mm	1.5	1.5	1.75	4.0	<u>+</u> 0.05			
16mm	+0.1 -0.0	1.5	<u>+</u> 0.1	<u>+</u> 0.1	2.0	0.6	0.6	0.1
24mm		1.5			<u>+</u> 0.1			

	Variable Dimensions Table 2								
Tape B1 E2 Min F P1 T2 Size Max					T2 Max	W Max	Ao, Bo & Ko		
	16 mm	12.1	14.25	7.5 <u>+</u> 0.1	8.0 <u>+</u> 0.1	8.0	16.3	Note 1	

Note 1: Embossed cavity to conform to EIA-481-B Dimensions in mm





		REE			
А	inches	7.0	10.0	13.0	
	mm	177.8	254.0	330.2	
в	inches	2.50	4.00	3.75	
	mm	63.5	101.6	95.3	Tape Width
С	mm	13	Width		
D	mm	16.4 16.4 16.4   +2.0 +2.0 +2.0   -0.0 -0.0 -0.0			16.0

Reel dimensions may vary

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425-776-1880



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#### **Contacting Pletronics Inc.**

Pletronics Inc. 19013 36<sup>th</sup> Ave. West Lynnwood, WA 98036-5761 USA Tel: 425-776-1880 Fax: 425-776-2760 E-mail: <u>ple-sales@pletronics.com</u> URL: <u>www.pletronics.com</u>

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